



**THE DATASHEET OF
CY7C199-15PC**





32K x 8 Static RAM

Features

- High speed
 - 10 ns
- Fast t_{DOE}
- CMOS for optimum speed/power
- Low active power
 - 467 mW (max, "L" version)
- Low standby power
 - 0.275 mW (max, "L" version)
- 2V data retention ("L" version only)
- Easy memory expansion with CE and OE features
- TTL-compatible inputs and outputs
- Automatic power-down when deselected

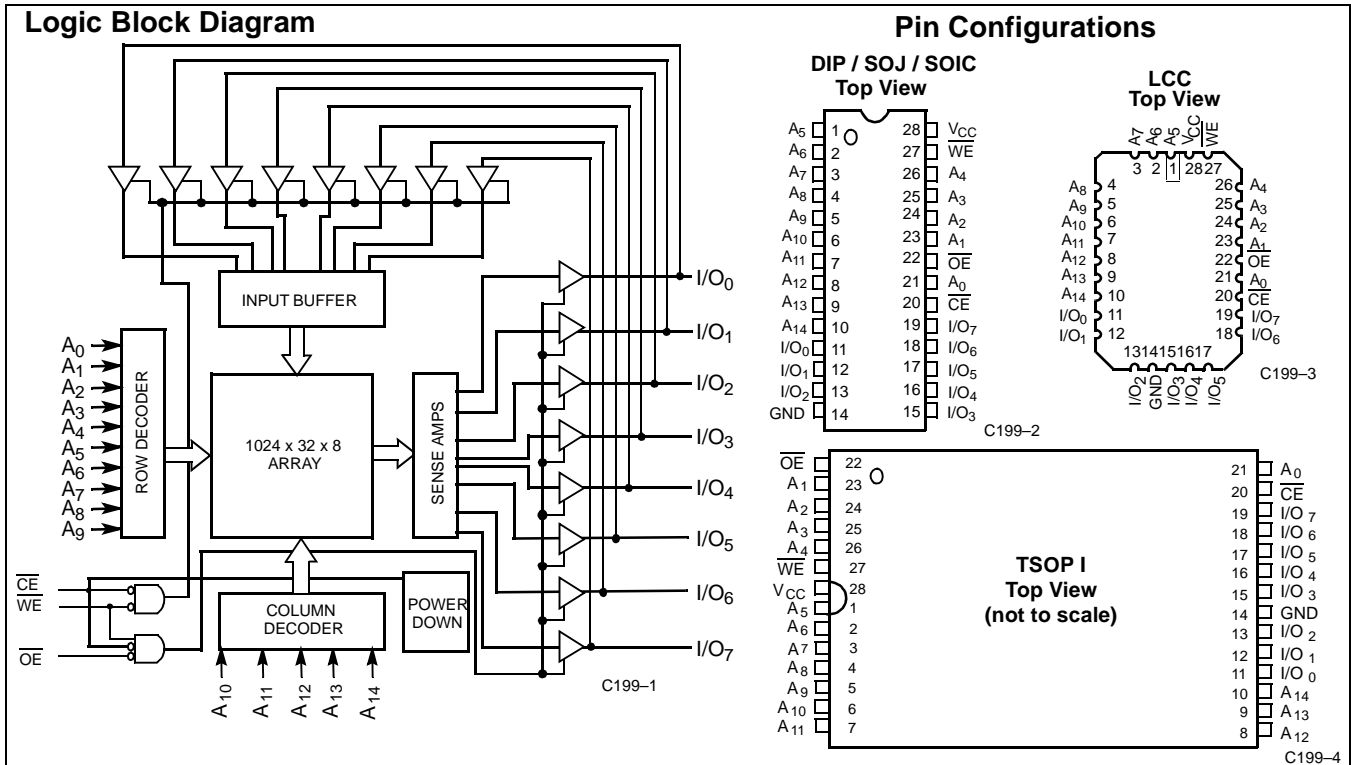
provided by an active LOW Chip Enable (\overline{CE}) and active LOW Output Enable (\overline{OE}) and three-state drivers. This device has an automatic power-down feature, reducing the power consumption by 81% when deselected. The CY7C199 is in the standard 300-mil-wide DIP, SOJ, and LCC packages.

An active LOW Write Enable signal (\overline{WE}) controls the writing/reading operation of the memory. When \overline{CE} and \overline{WE} inputs are both LOW, data on the eight data input/output pins (I/O₀ through I/O₇) is written into the memory location addressed by the address present on the address pins (A₀ through A₁₄). Reading the device is accomplished by selecting the device and enabling the outputs, \overline{CE} and \overline{OE} active LOW, while \overline{WE} remains inactive or HIGH. Under these conditions, the contents of the location addressed by the information on address pins are present on the eight data input/output pins.

The input/output pins remain in a high-impedance state unless the chip is selected, outputs are enabled, and Write Enable (\overline{WE}) is HIGH. A die coat is used to improve alpha immunity.

Functional Description

The CY7C199 is a high-performance CMOS static RAM organized as 32,768 words by 8 bits. Easy memory expansion is



Selection Guide

| | 7C199-8 | 7C199-10 | 7C199-12 | 7C199-15 | 7C199-20 | 7C199-25 | 7C199-35 | 7C199-45 |
|-----------------------------------|---------|----------|----------|----------|----------|----------|----------|----------|
| Maximum Access Time (ns) | 8 | 10 | 12 | 15 | 20 | 25 | 35 | 45 |
| Maximum Operating Current (mA) | | 120 | 110 | 160 | 155 | 150 | 140 | 140 |
| | L | | 90 | 90 | 90 | 80 | 70 | |
| Maximum CMOS Standby Current (mA) | | 0.5 | 0.5 | 10 | 10 | 10 | 10 | 10 |
| | L | | 0.05 | 0.05 | 0.05 | 0.05 | 0.05 | |

Shaded area contains advance information.

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

| | |
|---|-----------------|
| Storage Temperature | -65°C to +150°C |
| Ambient Temperature with Power Applied..... | -55°C to +125°C |
| Supply Voltage to Ground Potential (Pin 28 to Pin 14) | -0.5V to +7.0V |

DC Voltage Applied to Outputs

| | |
|--|---------------------------------------|
| in High Z State ^[1] | -0.5V to $V_{CC} + 0.5V$ |
| DC Input Voltage ^[1] | -0.5V to $V_{CC} + 0.5V$ |
| Output Current into Outputs (LOW)..... | 20 mA |
| Static Discharge Voltage | >2001V (per MIL-STD-883, Method 3015) |
| Latch-Up Current..... | >200 mA |

Operating Range

| Range | Ambient Temperature ^[2] | V_{CC} |
|------------|------------------------------------|----------|
| Commercial | 0°C to +70°C | 5V ± 10% |
| Industrial | -40°C to +85°C | 5V ± 10% |
| Military | -55°C to +125°C | 5V ± 10% |

Electrical Characteristics Over the Operating Range^[3]

| Parameter | Description | Test Conditions | 7C199-8 | | 7C199-10 | | 7C199-12 | | 7C199-15 | | Unit | |
|-----------|---|---|---------|-----------------|----------|-----------------|----------|-----------------|----------|-----------------|------|----|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | | |
| V_{OH} | Output HIGH Voltage | $V_{CC} = \text{Min.}, I_{OH} = -4.0 \text{ mA}$ | 2.4 | | 2.4 | | 2.4 | | 2.4 | | V | |
| V_{OL} | Output LOW Voltage | $V_{CC} = \text{Min.}, I_{OL} = 8.0 \text{ mA}$ | | 0.4 | | 0.4 | | 0.4 | | 0.4 | V | |
| V_{IH} | Input HIGH Voltage | | 2.2 | $V_{CC} + 0.3V$ | 2.2 | $V_{CC} + 0.3V$ | 2.2 | $V_{CC} + 0.3V$ | 2.2 | $V_{CC} + 0.3V$ | V | |
| V_{IL} | Input LOW Voltage | | -0.5 | 0.8 | -0.5 | 0.8 | -0.5 | 0.8 | -0.5 | 0.8 | V | |
| I_{IX} | Input Load Current | $GND \leq V_I \leq V_{CC}$ | -5 | +5 | -5 | +5 | -5 | +5 | -5 | +5 | µA | |
| I_{OZ} | Output Leakage Current | $GND \leq V_O \leq V_{CC}$, Output Disabled | -5 | +5 | -5 | +5 | -5 | +5 | -5 | +5 | µA | |
| I_{CC} | V_{CC} Operating Supply Current | $V_{CC} = \text{Max.}, I_{OUT} = 0 \text{ mA}, f = f_{MAX} = 1/t_{RC}$ | Com'l | | 120 | | 110 | | 160 | | 155 | mA |
| | | | L | | | | 85 | | 85 | | 100 | mA |
| | | | Mil | | | | | | | 180 | | mA |
| I_{SB1} | Automatic CE Power-Down Current—TTL Inputs | Max. V_{CC} , $CE \geq V_{IH}$, $V_{IN} \geq V_{IH}$ or $V_{IN} \leq V_{IL}$, $f = f_{MAX}$ | Com'l | | 5 | | 5 | | 30 | | 30 | mA |
| | | | L | | | | 5 | | 5 | | 5 | mA |
| I_{SB2} | Automatic CE Power-Down Current—CMOS Inputs | Max. V_{CC} , $CE \geq V_{CC} - 0.3V$, $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$, $f = 0$ | Com'l | | 0.5 | | 0.5 | | 10 | | 10 | mA |
| | | | L | | 0.05 | | 0.05 | | 0.05 | | 0.05 | mA |
| | | | Mil | | | | | | | 15 | | mA |

Shaded area contains advance information.

Notes:

- $V_{IL}(\text{min.}) = -2.0V$ for pulse durations of less than 20 ns.
- T_A is the "instant on" case temperature.
- See the last page of this specification for Group A subgroup testing information.

Electrical Characteristics Over the Operating Range^[3] (continued)

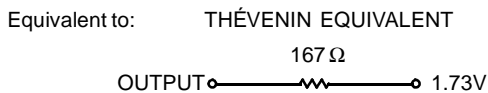
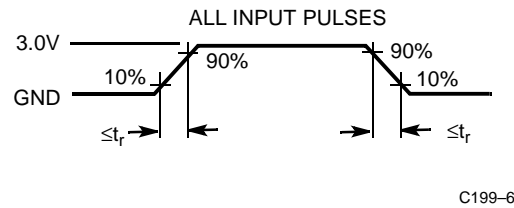
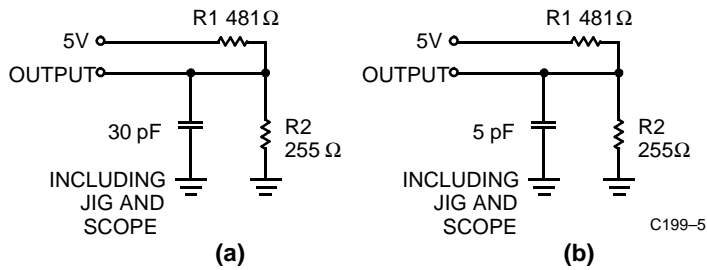
| Parameter | Description | Test Conditions | 7C199-20 | | 7C199-25 | | 7C199-35 | | 7C199-45 | | Unit |
|------------------|---|--|----------|------------------------|----------|------------------------|----------|------------------------|----------|------------------------|------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| V _{OH} | Output HIGH Voltage | V _{CC} = Min., I _{OH} = -4.0 mA | 2.4 | | 2.4 | | 2.4 | | 2.4 | | V |
| V _{OL} | Output LOW Voltage | V _{CC} = Min., I _{OL} = 8.0 mA | | 0.4 | | 0.4 | | 0.4 | | 0.4 | V |
| V _{IH} | Input HIGH Voltage | | 2.2 | V _{CC} + 0.3V | 2.2 | V _{CC} + 0.3V | 2.2 | V _{CC} + 0.3V | 2.2 | V _{CC} + 0.3V | V |
| V _{IL} | Input LOW Voltage | | -0.5 | 0.8 | -0.5 | 0.8 | -0.5 | 0.8 | -0.5 | 0.8 | V |
| I _{Ix} | Input Load Current | GND ≤ V _I ≤ V _{CC} | -5 | +5 | -5 | +5 | -5 | +5 | -5 | +5 | μA |
| I _{OZ} | Output Leakage Current | GND ≤ V _I ≤ V _{CC} , Output Disabled | -5 | +5 | -5 | +5 | -5 | +5 | -5 | +5 | μA |
| I _{CC} | V _{CC} Operating Supply Current | V _{CC} = Max., I _{OUT} = 0 mA, f = f _{MAX} = 1/t _{RC} | Com'l | 150 | | 150 | | 140 | | 140 | mA |
| | | | L | 90 | | 80 | | 70 | | 70 | mA |
| | | | Mil | 170 | | 150 | | 150 | | 150 | mA |
| I _{SB1} | Automatic CE Power-Down Current—TTL Inputs | Max. V _{CC} , $\overline{CE} \geq V_{IH}$, V _{IN} ≥ V _{IH} or V _{IN} ≤ V _{IL} , f = f _{MAX} | Com'l | 30 | | 30 | | 25 | | 25 | mA |
| | | | L | 5 | | 5 | | 5 | | 5 | mA |
| I _{SB2} | Automatic CE Power-Down Current—CMOS Inputs | Max. V _{CC} , $\overline{CE} \geq V_{CC} - 0.3V$, V _{IN} ≥ V _{CC} - 0.3V or V _{IN} ≤ 0.3V, f = 0 | Com'l | 10 | | 10 | | 10 | | 10 | mA |
| | | | L | 0.05 | | 0.05 | | 0.05 | | 0.05 | μA |
| | | | Mil | 15 | | 15 | | 15 | | 15 | mA |

Capacitance^[4]

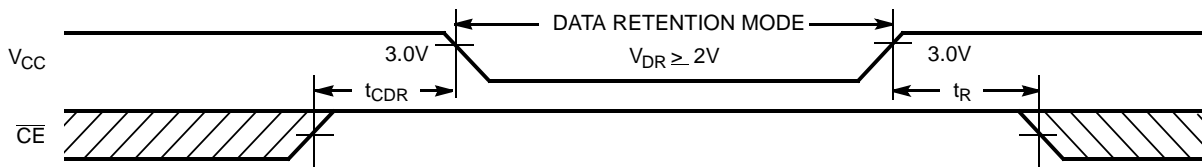
| Parameter | Description | Test Conditions | Max. | Unit |
|------------------|--------------------|--|------|------|
| C _{IN} | Input Capacitance | T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V | 8 | pF |
| C _{OUT} | Output Capacitance | | 8 | pF |

Note:

4. Tested initially and after any design or process changes that may affect these parameters.

AC Test Loads and Waveforms^[5]

Data Retention Characteristics Over the Operating Range (L version only)

| Parameter | Description | Conditions ^[6] | Min. | Max. | Unit |
|-----------------|--------------------------------------|---|------|------|---------|
| V_{DR} | V_{CC} for Data Retention | | 2.0 | | V |
| I_{CCDR} | Data Retention Current | Com'l | | | μA |
| | | Com'l L | | 10 | μA |
| $t_{CDR}^{[4]}$ | Chip Deselect to Data Retention Time | $V_{CC} = V_{DR} = 2.0V$, $CE \geq V_{CC} - 0.3V$, $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$ | 0 | | ns |
| $t_R^{[5]}$ | Operation Recovery Time | | 200 | | μs |

Data Retention Waveform

Note:

- $t_R \leq 3$ ns for the -12 and the -15 speeds. $t_R \leq 5$ ns for the -20 and slower speeds
- No input may exceed $V_{CC} + 0.5V$.

Switching Characteristics Over the Operating Range^[3, 7]

| Parameter | Description | 7C199-8 | | 7C199-10 | | 7C199-12 | | 7C199-15 | | Unit |
|--|--|---------|------|----------|------|----------|------|----------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| READ CYCLE | | | | | | | | | | |
| t_{RC} | Read Cycle Time | 8 | | 10 | | 12 | | 15 | | ns |
| t_{AA} | Address to Data Valid | | 8 | | 10 | | 12 | | 15 | ns |
| t_{OHA} | Data Hold from Address Change | 3 | | 3 | | 3 | | 3 | | ns |
| t_{ACE} | \overline{CE} LOW to Data Valid | | 8 | | 10 | | 12 | | 15 | ns |
| t_{DOE} | \overline{OE} LOW to Data Valid | | 4.5 | | 5 | | 5 | | 7 | ns |
| t_{LZOE} | \overline{OE} LOW to Low Z ^[8] | 0 | | 0 | | 0 | | 0 | | ns |
| t_{HZOE} | \overline{OE} HIGH to High Z ^[8, 9] | | 5 | | 5 | | 5 | | 7 | ns |
| t_{LZCE} | \overline{CE} LOW to Low Z ^[8] | 3 | | 3 | | 3 | | 3 | | ns |
| t_{HZCE} | \overline{CE} HIGH to High Z ^[8, 9] | | 4 | | 5 | | 5 | | 7 | ns |
| t_{PU} | \overline{CE} LOW to Power-Up | 0 | | 0 | | 0 | | 0 | | ns |
| t_{PD} | \overline{CE} HIGH to Power-Down | | 8 | | 10 | | 12 | | 15 | ns |
| WRITE CYCLE ^[10, 11] | | | | | | | | | | |
| t_{WC} | Write Cycle Time | 8 | | 10 | | 12 | | 15 | | ns |
| t_{SCE} | \overline{CE} LOW to Write End | 7 | | 7 | | 9 | | 10 | | ns |
| t_{AW} | Address Set-Up to Write End | 7 | | 7 | | 9 | | 10 | | ns |
| t_{HA} | Address Hold from Write End | 0 | | 0 | | 0 | | 0 | | ns |
| t_{SA} | Address Set-Up to Write Start | 0 | | 0 | | 0 | | 0 | | ns |
| t_{PWE} | \overline{WE} Pulse Width | 7 | | 7 | | 8 | | 9 | | ns |
| t_{SD} | Data Set-Up to Write End | 5 | | 5 | | 8 | | 9 | | ns |
| t_{HD} | Data Hold from Write End | 0 | | 0 | | 0 | | 0 | | ns |
| t_{HZWE} | \overline{WE} LOW to High Z ^[9] | | 5 | | 6 | | 7 | | 7 | ns |
| t_{LZWE} | \overline{WE} HIGH to Low Z ^[8] | 3 | | 3 | | 3 | | 3 | | ns |

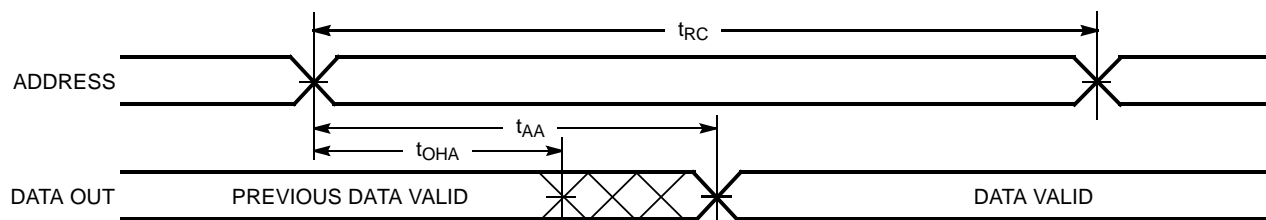
Shaded area contains advance information.

Notes:

7. Test conditions assume signal transition time of 3 ns or less for -12 and -15 speeds and 5 ns or less for -20 and slower speeds, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
8. At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE} , t_{HZOE} is less than t_{LZOE} , and t_{HZWE} is less than t_{LZWE} for any given device.
9. t_{HZOE} , t_{HZCE} , and t_{HZWE} are specified with $C_L = 5$ pF as in part (b) of AC Test Loads. Transition is measured ± 500 mV from steady-state voltage.
10. The internal write time of the memory is defined by the overlap of \overline{CE} LOW and \overline{WE} LOW. Both signals must be LOW to initiate a write and either signal can terminate a write by going HIGH. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.
11. The minimum write cycle time for write cycle #3 (\overline{WE} controlled, \overline{OE} LOW) is the sum of t_{HZWE} and t_{SD} .

Switching Characteristics Over the Operating Range^[3,7] (continued)

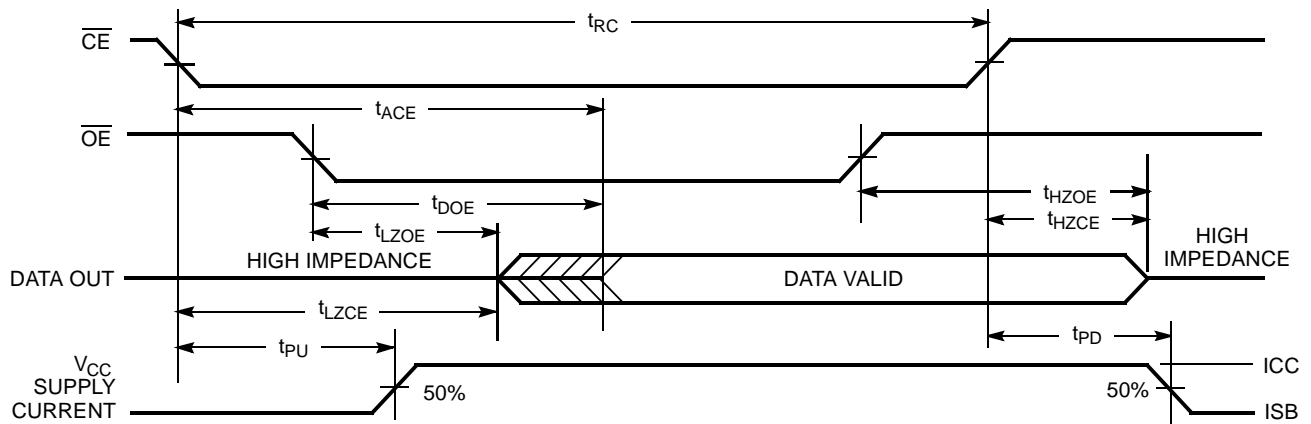
| Parameter | Description | 7C199-20 | | 7C199-25 | | 7C199-35 | | 7C199-45 | | Unit |
|---------------------------------------|--|----------|------|----------|------|----------|------|----------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| READ CYCLE | | | | | | | | | | |
| t_{RC} | Read Cycle Time | 20 | | 25 | | 35 | | 45 | | ns |
| t_{AA} | Address to Data Valid | | 20 | | 25 | | 35 | | 45 | ns |
| t_{OHA} | Data Hold from Address Change | 3 | | 3 | | 3 | | 3 | | ns |
| t_{ACE} | \overline{CE} LOW to Data Valid | | 20 | | 25 | | 35 | | 45 | ns |
| t_{DOE} | \overline{OE} LOW to Data Valid | | 9 | | 10 | | 16 | | 16 | ns |
| t_{LZOE} | \overline{OE} LOW to Low Z ^[8] | 0 | | 0 | | 0 | | 0 | | ns |
| t_{HZOE} | \overline{OE} HIGH to High Z ^[8, 9] | | 9 | | 11 | | 15 | | 15 | ns |
| t_{LZCE} | \overline{CE} LOW to Low Z ^[8] | 3 | | 3 | | 3 | | 3 | | ns |
| t_{HZCE} | \overline{CE} HIGH to High Z ^[8, 9] | | 9 | | 11 | | 15 | | 15 | ns |
| t_{PU} | \overline{CE} LOW to Power-Up | 0 | | 0 | | 0 | | 0 | | ns |
| t_{PD} | \overline{CE} HIGH to Power-Down | | 20 | | 20 | | 20 | | 25 | ns |
| WRITE CYCLE ^[10,11] | | | | | | | | | | |
| t_{WC} | Write Cycle Time | 20 | | 25 | | 35 | | 45 | | ns |
| t_{SCE} | \overline{CE} LOW to Write End | 15 | | 18 | | 22 | | 22 | | ns |
| t_{AW} | Address Set-Up to Write End | 15 | | 20 | | 30 | | 40 | | ns |
| t_{HA} | Address Hold from Write End | 0 | | 0 | | 0 | | 0 | | ns |
| t_{SA} | Address Set-Up to Write Start | 0 | | 0 | | 0 | | 0 | | ns |
| t_{PWE} | \overline{WE} Pulse Width | 15 | | 18 | | 22 | | 22 | | ns |
| t_{SD} | Data Set-Up to Write End | 10 | | 10 | | 15 | | 15 | | ns |
| t_{HD} | Data Hold from Write End | 0 | | 0 | | 0 | | 0 | | ns |
| t_{HZWE} | \overline{WE} LOW to High Z ^[9] | | 10 | | 11 | | 15 | | 15 | ns |
| t_{LZWE} | \overline{WE} HIGH to Low Z ^[8] | 3 | | 3 | | 3 | | 3 | | ns |

Switching Waveforms
Read Cycle No. 1^[12, 13]


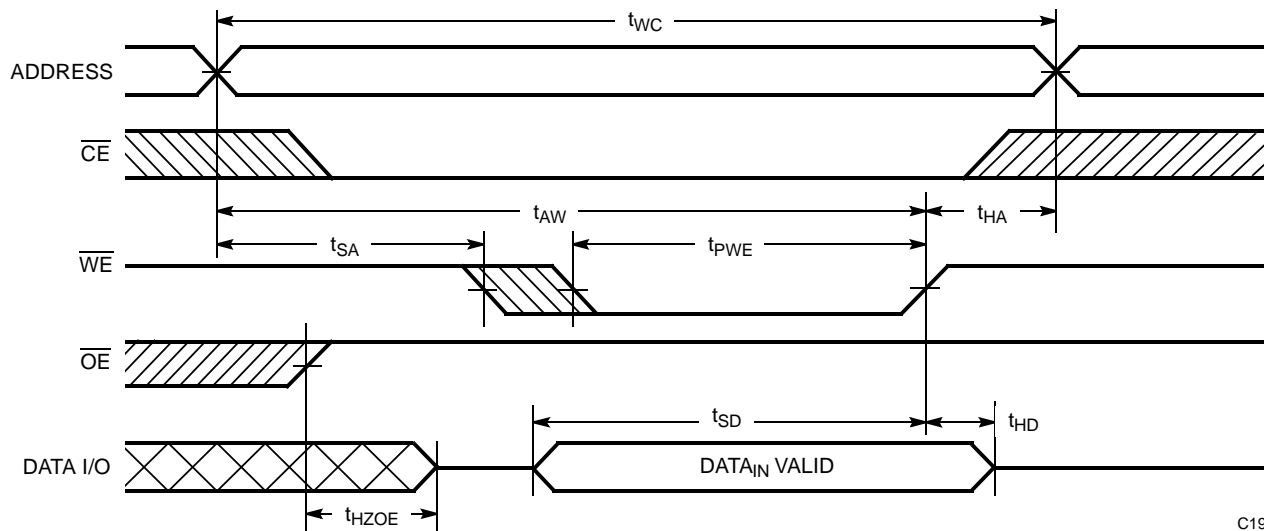
C199-8

Notes:

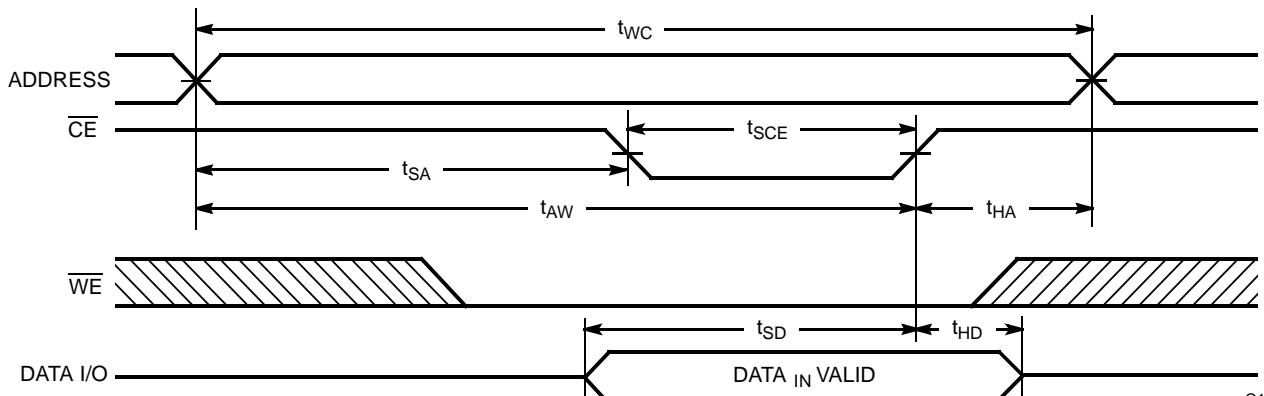
12. Device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$.
 13. \overline{WE} is HIGH for read cycle.

Switching Waveforms (continued)
Read Cycle No. 2 [13, 14]


C199-9

Write Cycle No. 1 (WE Controlled) [10, 15, 16]


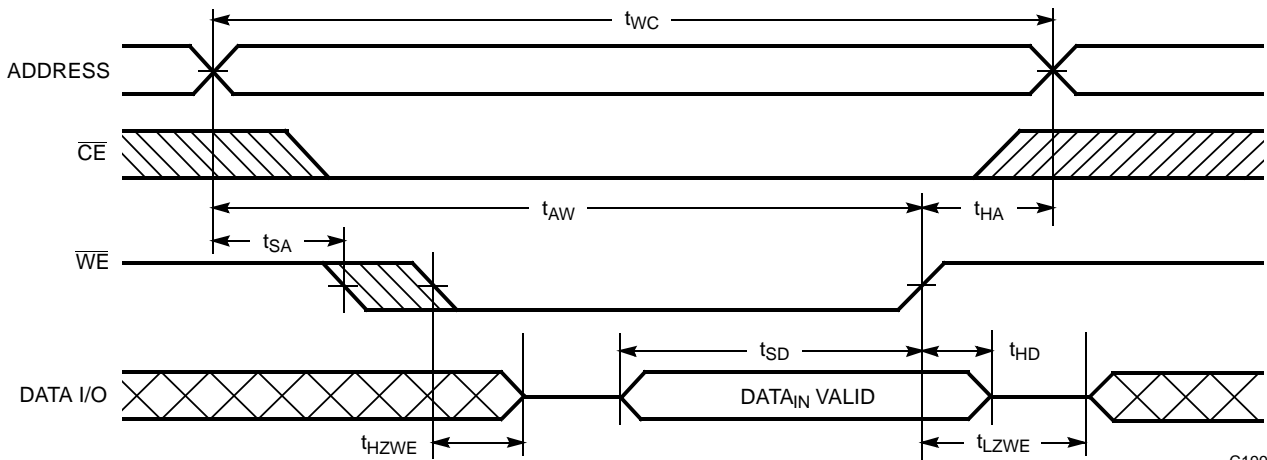
C199-10

Write Cycle No. 2 (CE Controlled) [10, 15, 16]


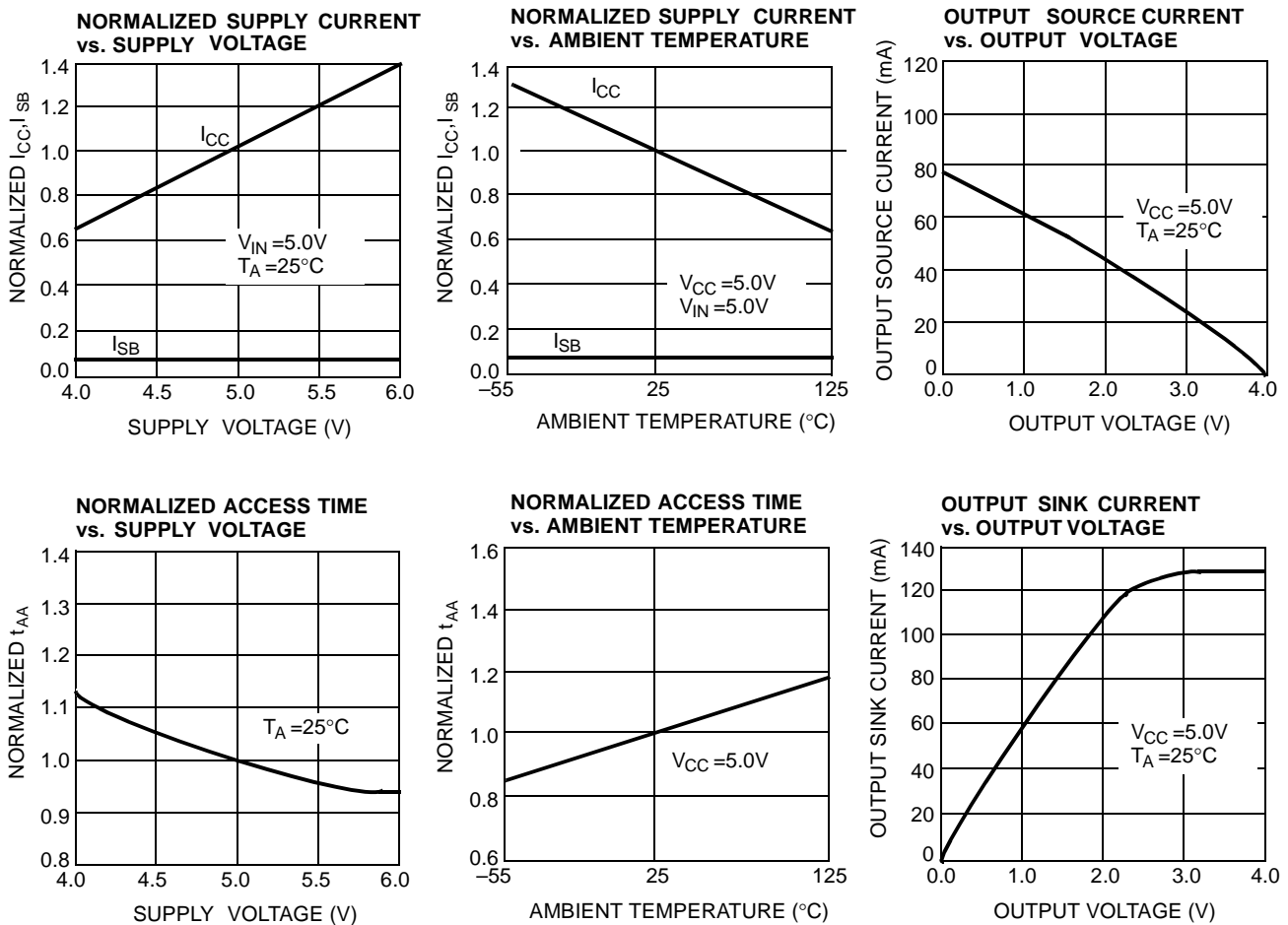
C199-11

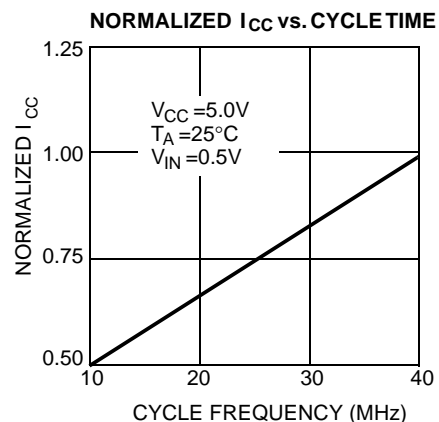
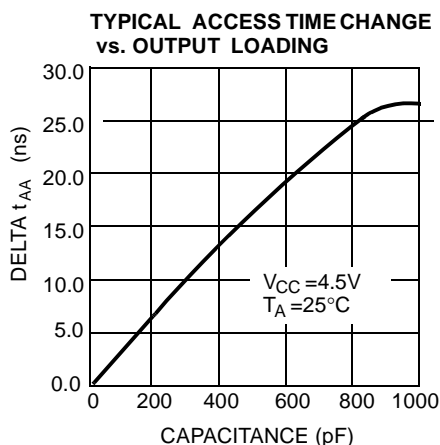
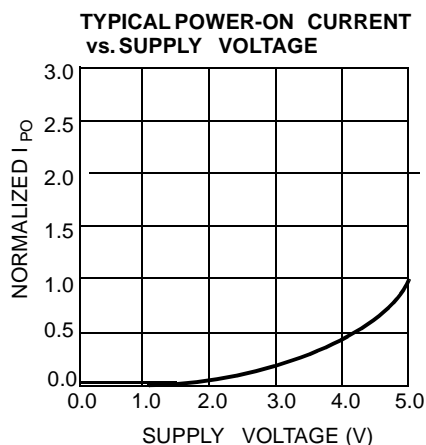
Notes:

14. Address valid prior to or coincident with \overline{CE} transition LOW.
15. Data I/O is high impedance if $OE = V_{IH}$.
16. If \overline{CE} goes HIGH simultaneously with WE HIGH, the output remains in a high-impedance state.

Switching Waveforms (continued)
Write Cycle No. 3 (WE Controlled \overline{OE} LOW)^[11, 16]


C199-12

Typical DC and AC Characteristics


Typical DC and AC Characteristics (continued)

Truth Table

| CE | WE | OE | Inputs/Outputs | Mode | Power |
|----|----|----|----------------|---------------------------|----------------------|
| H | X | X | High Z | Deselect/Power-Down | Standby (I_{SB}) |
| L | H | L | Data Out | Read | Active (I_{CC}) |
| L | L | X | Data In | Write | Active (I_{CC}) |
| L | H | H | High Z | Deselect, Output Disabled | Active (I_{CC}) |

Ordering Information

| Speed (ns) | Ordering Code | Package Name | Package Type | Operating Range |
|------------|---------------|--------------|------------------------------------|-----------------|
| 8 | CY7C199-8VC | V21 | 28-Lead Molded SOJ | Commercial |
| | CY7C199-8ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199L-8VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199L-8ZC | Z28 | 28-Lead Thin Small Outline Package | |
| 10 | CY7C199-10VC | V21 | 28-Lead Molded SOJ | Commercial |
| | CY7C199-10ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199L-10VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199L-10ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199-10VI | V21 | 28-Lead Molded SOJ | Industrial |
| | CY7C199-10ZI | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199L-10VI | V21 | 28-Lead Molded SOJ | |
| | CY7C199L-10ZI | Z28 | 28-Lead Thin Small Outline Package | |
| 12 | CY7C199-12PC | P21 | 28-Lead (300-Mil) Molded DIP | Commercial |
| | CY7C199-12VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199-12ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199L-12PC | P21 | 28-Lead (300-Mil) Molded DIP | |
| | CY7C199L-12VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199L-12ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199-12VI | V21 | 28-Lead Molded SOJ | Industrial |
| | CY7C199-12ZI | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199L-12VI | V21 | 28-Lead Molded SOJ | |
| | CY7C199L-12ZI | Z28 | 28-Lead Thin Small Outline Package | |

Shaded area contains advance information. Contact your Cypress sales representative for availability

Ordering Information (continued)

| Speed (ns) | Ordering Code | Package Name | Package Type | Operating Range |
|------------|----------------|--------------|--|-----------------|
| 15 | CY7C199-15PC | P21 | 28-Lead (300-Mil) Molded DIP | Commercial |
| | CY7C199-15VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199-15ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199L-15PC | P21 | 28-Lead (300-Mil) Molded DIP | |
| | CY7C199L-15VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199L-15ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199-15VI | V21 | 28-Lead Molded SOJ | Industrial |
| | CY7C199-15ZI | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199-15DMB | D22 | 28-Lead (300-Mil) CerDIP | Military |
| | CY7C199-15LMB | L54 | 28-Pin Rectangular Leadless Chip Carrier | |
| | CY7C199L-15DMB | D22 | 28-Lead (300-Mil) CerDIP | |
| | CY7C199L-15LMB | L54 | 28-Pin Rectangular Leadless Chip Carrier | |
| 20 | CY7C199-20PC | P21 | 28-Lead (300-Mil) Molded DIP | Commercial |
| | CY7C199-20VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199-20ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199L-20PC | P21 | 28-Lead (300-Mil) Molded DIP | |
| | CY7C199L-20VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199L-20ZC | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199-20VI | V21 | 28-Lead Molded SOJ | Industrial |
| | CY7C199-20ZI | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199-20DMB | D22 | 28-Lead (300-Mil) CerDIP | Military |
| | CY7C199-20LMB | L54 | 28-Pin Rectangular Leadless Chip Carrier | |
| | CY7C199L-20DMB | D22 | 28-Lead (300-Mil) CerDIP | |
| | CY7C199L-20LMB | L54 | 28-Pin Rectangular Leadless Chip Carrier | |
| 25 | CY7C199-25PC | P21 | 28-Lead (300-Mil) Molded DIP | Commercial |
| | CY7C199-25SC | S21 | 28-Lead Molded SOIC | |
| | CY7C199-25VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199-25ZC | Z28 | 28-Lead Thin Small Outline Package | Industrial |
| | CY7C199L-25ZI | Z28 | 28-Lead Thin Small Outline Package | |
| | CY7C199-25DMB | D22 | 28-Lead (300-Mil) CerDIP | |
| | CY7C199-25LMB | L54 | 28-Pin Rectangular Leadless Chip Carrier | |
| 35 | CY7C199-35PC | P21 | 28-Lead (300-Mil) Molded DIP | Commercial |
| | CY7C199-35SC | S21 | 28-Lead Molded SOIC | |
| | CY7C199-35VC | V21 | 28-Lead Molded SOJ | |
| | CY7C199-35ZC | Z28 | 28-Lead Thin Small Outline Package | Military |
| | CY7C199-35DMB | D22 | 28-Lead (300-Mil) CerDIP | |
| | CY7C199-35LMB | L54 | 28-Pin Rectangular Leadless Chip Carrier | |
| 45 | CY7C199-45DMB | D22 | 28-Lead (300-Mil) CerDIP | Military |
| | CY7C199-45LMB | L54 | 28-Pin Rectangular Leadless Chip Carrier | |

Shaded area contains advance information. Contact your Cypress sales representative for availability

MILITARY SPECIFICATIONS
Group A Subgroup Testing
DC Characteristics

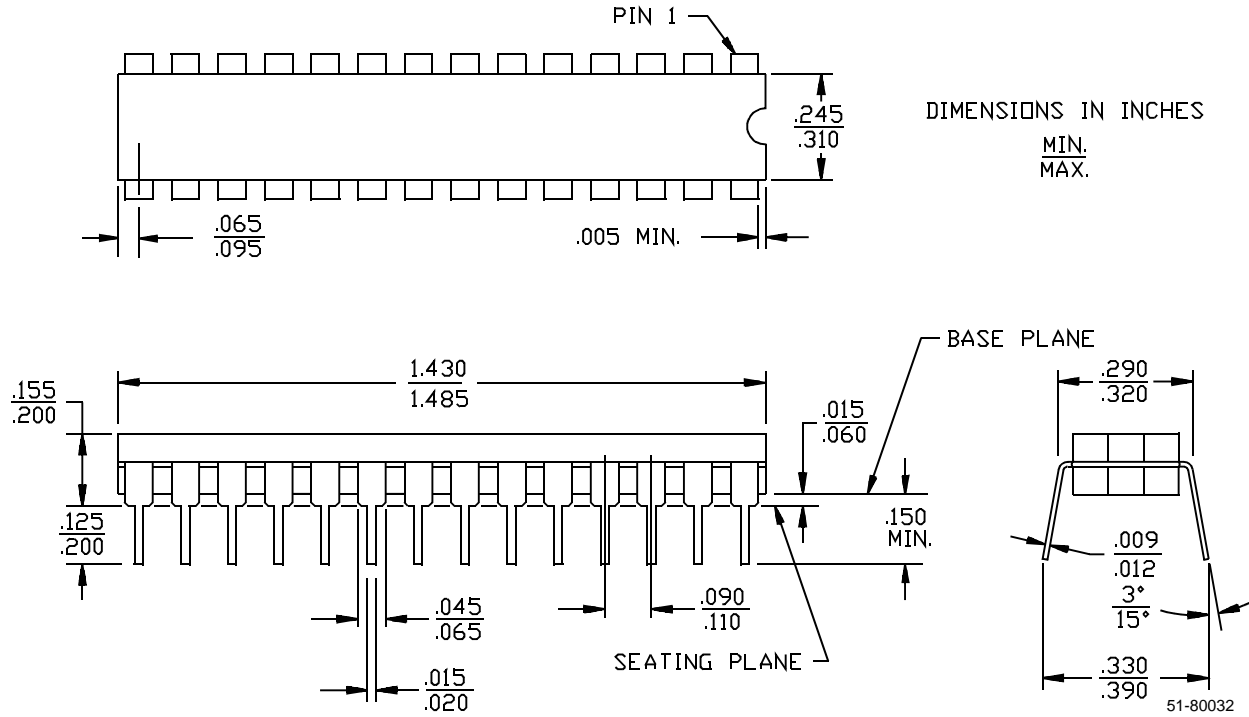
| Parameter | Subgroups |
|---------------|-----------|
| V_{OH} | 1, 2, 3 |
| V_{OL} | 1, 2, 3 |
| V_{IH} | 1, 2, 3 |
| $V_{IL Max.}$ | 1, 2, 3 |
| I_{IX} | 1, 2, 3 |
| I_{OZ} | 1, 2, 3 |
| I_{CC} | 1, 2, 3 |
| I_{SB1} | 1, 2, 3 |
| I_{SB2} | 1, 2, 3 |

Switching Characteristics

| Parameter | Subgroups |
|--------------------|-----------------|
| READ CYCLE | |
| t_{RC} | 7, 8, 9, 10, 11 |
| t_{AA} | 7, 8, 9, 10, 11 |
| t_{OHA} | 7, 8, 9, 10, 11 |
| t_{ACE} | 7, 8, 9, 10, 11 |
| t_{DOE} | 7, 8, 9, 10, 11 |
| WRITE CYCLE | |
| t_{WC} | 7, 8, 9, 10, 11 |
| t_{AA} | 7, 8, 9, 10, 11 |
| t_{AW} | 7, 8, 9, 10, 11 |
| t_{HA} | 7, 8, 9, 10, 11 |
| t_{SA} | 7, 8, 9, 10, 11 |
| t_{PWE} | 7, 8, 9, 10, 11 |
| t_{SD} | 7, 8, 9, 10, 11 |
| t_{HD} | 7, 8, 9, 10, 11 |

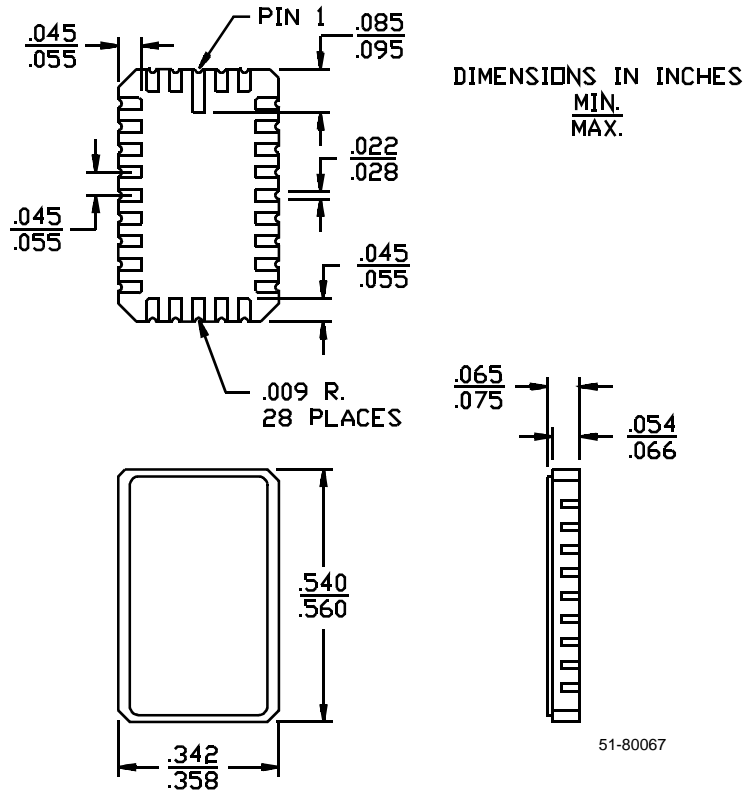
Package Diagrams

28-Lead (300-Mil) CerDIP D22
MIL-STD-1835 D-15 Config. A

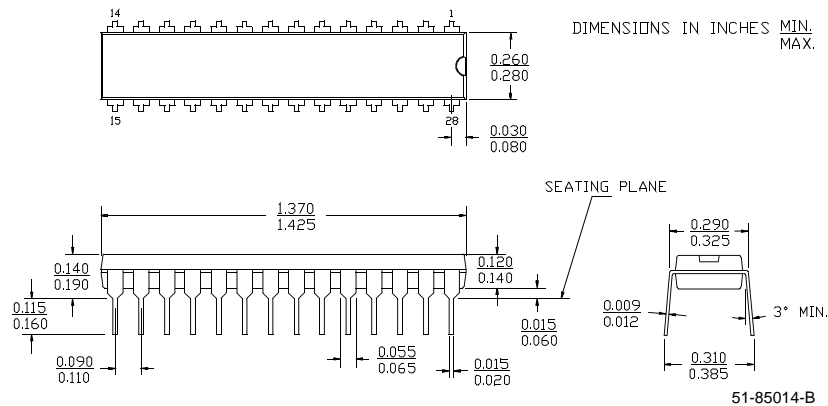


Package Diagrams (continued)

28-Pin Rectangular Leadless Chip Carrier L54
MIL-STD-183C-11A

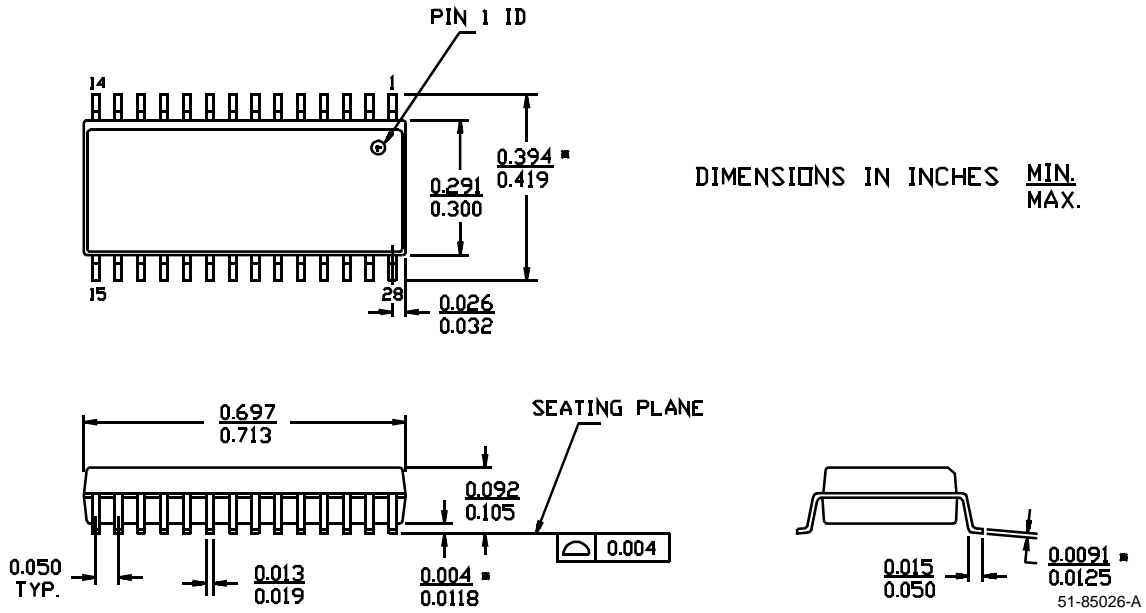


28-Lead (300-Mil) Molded DIP P21

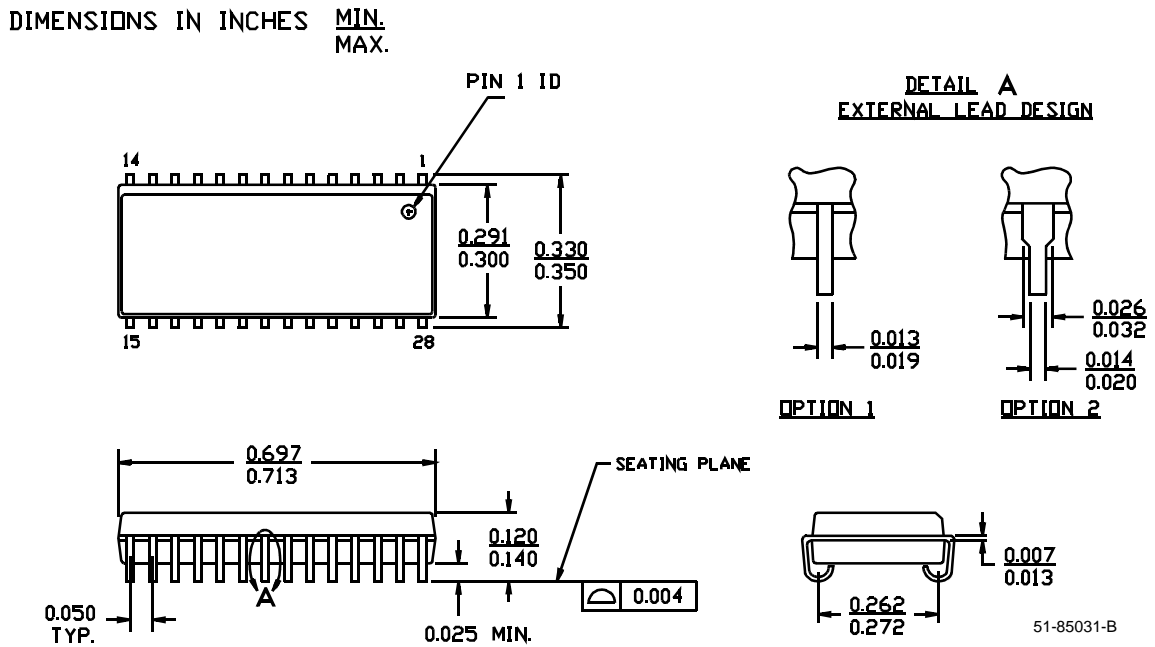


Package Diagrams (continued)

28-Lead (300-Mil) Molded SOIC S21

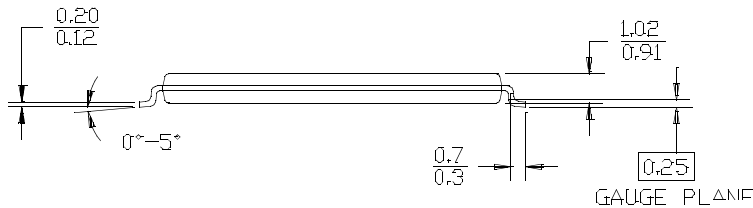
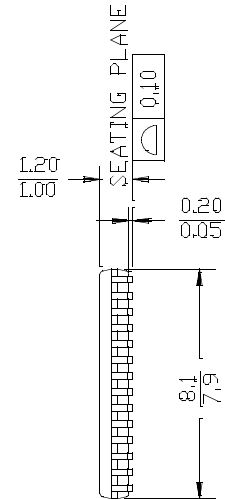
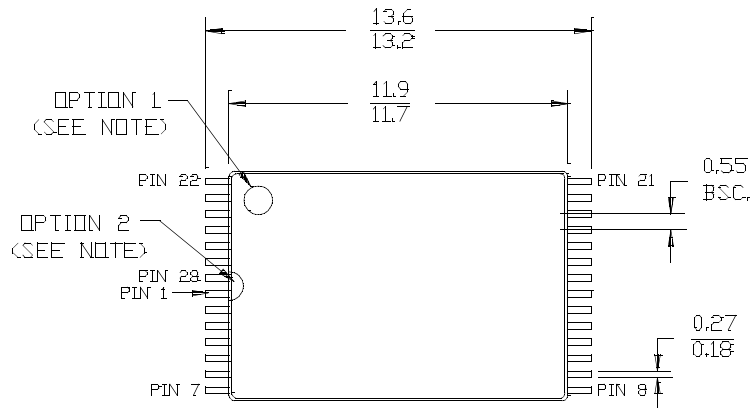


28-Lead (300-Mil) Molded SOJ V21



Package Diagrams (continued)
28-Lead Thin Small Outline Package Z28

NOTE: ORIENTATION I.D. MAY BE LOCATED EITHER AS SHOWN IN OPTION 1 OR OPTION 2





DIMENSION IN MM
MAX.
MIN.

51-85071-F

| Document Title: CY7C199 32K x 8 Static RAM Document Number: 38-05160 | | | | |
|---|----------------|-------------------|------------------------|---|
| REV. | ECN NO. | Issue Date | Orig. of Change | Description of Change |
| ** | 109971 | 10/28/01 | SZV | Change from Spec number: 38-00239 to 38-05160 |

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